CMOS CAMERA MODULES

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KLT-X3MF-OX03A10 V1.0

OmniVision OX03A10 MIPI Interfaccia Messa a fuoco fissa 2MP M12 Modulo telecamera



Modulo telecamera n.	KLT-X3MF-OX03A10 V1.0
Sensore d'immagine	OX03A10
EFL	3.24 mm
F.NO	2.7
Pixel	1920 x 1080
Vista ad angolo	100°(D) 87°(H) 71°(V)
Tipo di lente	1/2.44 pollice
Dimensioni dell'obiettivo	14.00 x 14.00 x 23.32 mm
Dimensione del modulo	40.00 x 23.00 mm
Tipo di modulo	Messa a fuoco fissa
Interfaccia	MIPI



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OXO3A10 2.46MP product brief



Industry-Leading Low-Light Performance and High Dynamic Range for a Wide Range of Automotive Applications

OmniVision's OX03A10 is a high-performance, lowpower 3.2 micron OmniBSI[™]-2 image sensor designed for a wide range of advanced automotive imaging applications, including 360-degree surround view, rear view, blind-spot detection, e-mirror, and lane departure warning.

available in

lead-free

package

The 2.46 megapixel sensor uses OmniVision's proprietary Deep Well[™] pixel technology to deliver industry-leading low-light sensitivity, and enables up to 90 dB of high dynamic range (HDR) from a single exposure without any decrease in signal-to-noise ratio and without motion artifacts. The OX03A10 also features dual-exposure HDR mode that can extend the sensor's dynamic range to more than 120 dB. The OXO3A10 can output multiple resolution formats, including 1920 x 1280 resolution video at 50 frames per second (fps) and 1920 x 1080 resolution video at 60 fps.

The sensor comes in an AEC-Q100 Grade 2-qualified 8.0 x 7.2 mm chip-scale package or 10.0 x 9.0 mm ball grid array package and has been developed according to ISO 26262 ASIL B requirements.

Find out more at www.ovt.com.





Applications

Automotive

- 360° Surround View System - Rear View Camera - Lane Departure Warning / Lane Keep Assist

- Camera Monitoring System/e-mirror Autonomous Driving

Product Specifications

- active array size: 1920 × 1280
- power supply: analog: 3.3V - digital: 1.2V - I/O pads: 1.8V
- power requirements:
 active: streaming @ 1280p50: 370 mW (with FuSa/ASIL off)
- temperature range:
 operating: -40°C to +105°C sensor ambient temperature and -40°C to +125°C junction temperature
- output interfaces: up to 4-lane MIPI CSI-2
- input clock frequency: 6 36 MHz
- lens size: 1/2.44"
- lens chief ray angle: 19.7°
- SCCB speed: up to 1 MHz
- scan mode: progressive
- shutter: rolling shutter
- max S/N ratio: 45.4 dB

- output formats: single exposure HDR - 16-bit combined RAW, 12-bit (PWL) compressed combined RAW; dual exposure HDR - 16-bit combined RAW + 12-bit VS RAW, 12-bit (PWL) compressed combined RAW + 12-bit VSRAW
- maximum image transfer rate: - 1280p: 50 fps

 - 1080p: 60 fps 1280p (with FuSa/ASIL on): 40 fps - 1080p (with FuSa/ASIL on): 45 fps
- sensitivity: 35,000 e⁻/Lux-sec (green pixel response at 530 nm illumination)
- dynamic range: 90 dB single exposure HDR >120 dB dual exposure staggered HDR
- pixel size: 3.2 µm x 3.2 µm
- image area: 6195.2 μm x 4147.2 μm
- package cover glass type: double sided anti-reflective (AR/AR) coating (without IRCF)
- package dimensions: a-CSP[™]: 8034 μm x 7210 μm a-BGA[™]: 10 mm x 9 mm

- OX03A10-E80Y-1E-Z (color, lead-free) 80-pin a-CSP[™] packed in tray without protective film
- OX03A10-E80Y-OE-Z (color, lead-free) 80-pin a-CSP[™] packed in tape & reel wth protective film (TL)
- OXO3A10-E80Y-LE-Z (color, lead-free) 80-pin a-CSP[™] packed in tray with protective film (TL)
- OX03A10-E80Y-SE-Z (color, lead-free) 80-pin a-CSP[™] packed in tape & reel wth protective film (BL)
- OX03A10-E80Y-QE-Z (color, lead-free) 80-pin a-CSP[™] packed in tray with protective film (BL)
- OX03A10-B83Y-1E-Z (color, lead-free) 83-pin a-BGA[™] packed in tray without protective film
- 0X03A10-B83Y-0E-Z (color, lead-free) 83-pin a-BGA[™] packed in tape & reel with protective film
- OX03A10-B83Y-LE-Z (color, lead-free) 83-pin a-BGA[™] packed in tray with protective film

Product Features

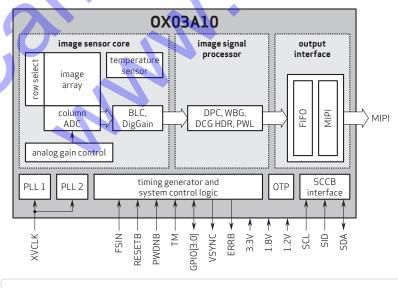
- support for image size: - 1920 x 1280 - 1920 x 1080
- VGA QVGA, and any cropped size
- high dynamic range
- high sensitivity
- image sensor processor functions: defective pixel cancelation
- HDR combination
- automatic black level correction PWL compression, etc.
- pixel data: 12b RAW RGB

SCCB for register programming

0X03A10

- dedicated safety features for supporting minimum ASILB applications
- programmable GPIOs
- high speed serial data transfer with MIPI CSI-2
- external frame synchronization capability
- embedded temperature sensor
- one time programmable (OTP) memory

Functional Block Diagram



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